

1700 V

310 A

WAS310M17BM3, WAS310M17BM3T

1700 V, 310 A, Silicon Carbide, Half-Bridge Module

Technical Features

- Industry Standard 62 mm Footprint
- High Humidity Operation THB-80 (HV-H3TRB)
- Ultra Low Loss, High-Frequency Operation
- Zero Reverse Recovery from Diodes
- Zero Turn-off Tail Current from MOSFET
- Normally-off, Fail-safe Device Operation
- Copper Baseplate and Aluminum Nitride Insulator

Typical Applications

- Induction Heating
- Motor Drives
- Renewables
- Railway Auxiliary & Traction
- EV Fast Charging
- UPS and SMPS



V_{DS}

I_{DS}

System Benefits

- 62 mm Form Factor Enables System Retrofit
- Increased System Efficiency, due to Low Switching & Conduction Losses of SiC

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	Note
Drain-Source Voltage	V _{DS}			1700			
Gate-Source Voltage, Maximum Value	V _{GS(max)}	-10		+23	V	Transient	Note 1
Gate-Source Voltage, Recommended	V _{GS(op)}		-4/+15			Static	Fig. 33
DC Continuous Drain Current	I _D		409			$V_{GS} = 15 \text{ V}, T_{C} = 25 ^{\circ}\text{C}, T_{VJ} \leq 175 ^{\circ}\text{C}$	_
			307			$V_{GS} = 15 \text{ V}, T_{C} = 90 ^{\circ}\text{C}, T_{VJ} \leq 175 ^{\circ}\text{C}$	
DC Source-Drain Current (Schottky Diode)	I _{SD(SD)}		482		A	$V_{GS} = -4 V, T_{C} = 25 °C, T_{VJ} \le 175 °C$ $t_{Pmax} limited by T_{VJmax} V_{GS} = 15 V, T_{C} = 25 °C$	
Pulsed Drain-Source Current	I _{DM}		620				
Power Dissipation	P _D		1630		W	T _c = 25 °C, T _{vJ} ≤ 175 °C	Note 4 Fig. 21
Virtual Junction Temperature	T _{VJ(op)}	-40		150	°C	Operation	
				175		Intermittent with Reduced Life	

Note (1): Recommended turn-on gate voltage is 15 V with ±5 % regulation tolerance. Not for use in linear region.

Note (2): Current limit calculated by $I_{D(max)} = \sqrt{(P_D/R_{DS(typ)}(T_{VJ(max)},I_{D(max)}))}$

Note (3): Verified by design

Note (4): $P_D = (T_{VJ} - T_C)/R_{TH(JC,typ)}$

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Key Parameters

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	Note
	-		тур.	Max.	Unit		Note
Drain-Source Breakdown Voltage	V _{(BR)DSS}	1700			-	V _{GS} = 0 V, T _{VJ} = -40 °C	
Gate Threshold Voltage	V _{GS(th)}	1.8	2.5	3.6	V	$V_{DS} = V_{GS}, I_D = 102 \text{ mA}$	
	V GS(th)		2.0			$V_{DS} = V_{GS}, I_D = 102 \text{ mA}, T_{VJ} = 175 \text{ °C}$	
Zero Gate Voltage Drain Current	I _{DSS}		26.4	2560	μΑ	V _{GS} = 0 V, V _{DS} = 1700 V	
Gate-Source Leakage Current	I _{GSS}		4	1000	nA	$V_{GS} = 15 V, V_{DS} = 0 V$	
			4.3	5.8	mΩ	$V_{GS} = 15 \text{ V}, I_{D} = 310 \text{ A}$	Fig. 2 _ Fig. 3
Drain-Source On-State Resistance (Devices Only)	R _{DS(on)}		8.4			$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 310 \text{ A}, \text{ T}_{VJ} = 150 ^{\circ}\text{C}$	
(Devices Only)			9.8			$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 310 \text{ A}, \text{ T}_{VJ} = 175 ^{\circ}\text{C}$	
Transconductance	g _{fs}		290		S	V _{DS} = 20 V, I _D = 310 A	- Fig. 4
			284			$V_{DS} = 20 \text{ V}, I_D = 310 \text{ A}, T_{VJ} = 150 \text{ °C}$	
Turn-On Switching Energy, $T_{VJ} = 25 ^{\circ}C$			4.4			V = 000 V	
T _{VJ} = 125 °C T _{VJ} = 150 °C	E _{On}		4.1 4.0			$V_{DD} = 900 V,$ $I_{D} = 310 A,$	Fig. 11 Fig. 13
Turn-Off Switching Energy, $T_{vJ} = 25 \text{ °C}$			7.2		mJ $V_{GS} = -4 V/15 V$, $R_{G(OFF)} = 1.0 \Omega$, $R_{G(ON)} = 1.0 \Omega$, $L = 13.6 \mu H$		
T _{VJ} = 125 °C	Eoff		7.4				
T _{vJ} = 150 °C			7.4				
Internal Gate Resistance	R _{G(int)}		1.85		Ω	f = 100 kHz	
Input Capacitance	C _{iss}		31.5		nF	nF V _{GS} = 0 V, V _{DS} = 1000 V, V _{AC} = 25 mV, f = 100 kHz	Fig. 9
Output Capacitance	Coss		1.8				
Reverse Transfer Capacitance	C _{rss}		45		pF		
Gate to Source Charge	Q _{GS}		320			$V_{DS} = 1200 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V},$ $I_D = 310 \text{ A},$ Per IEC60747-8-4 pg 21	
Gate to Drain Charge	Q _{GD}		280		nC I		
Total Gate Charge	Q _G		996		1		
FET Thermal Resistance, Junction to Case	R _{th JC}		0.092		°C/W		Fig. 17

Diode Characteristics (Per Position) (T_{vJ} = 25 °C Unless Otherwise Specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	Note
Diode Forward Voltage			1.78		v	$V_{GS} = -4 \text{ V}, I_F = 310 \text{ A}, T_{VJ} = 25 \text{ °C}$	- Fig. 7
	VF		2.50			$V_{GS} = -4 \text{ V}, \text{ I}_{F} = 310 \text{ A}, \text{ T}_{VJ} = 150 \text{ °C}$	
Reverse Recovery Time	t _{rr}		27		ns	V _{GS} = -4 V, I _{SD} = 310 A, V _R = 900 V di/dt = 26.5 A/ns, T _{VJ} = 150 °C	
Reverse Recovery Charge	Q _{rr}		4.5		μC		Fig. 32
Peak Reverse Recovery Current	Irrm		281		A		
Reverse Recovery Energy, T _{vJ} = 25 °C T _{vJ} = 125 °C T _{vJ} = 150 °C	Err		3.5 3.8 3.9		mJ	$\label{eq:V_DS} \begin{split} V_{\text{DS}} &= 900 \; \text{V}, \; \text{I}_{\text{D}} = 310 \; \text{A}, \\ V_{\text{GS}} &= -4 \; \text{V}/15 \; \text{V}, \; \text{R}_{\text{G}(\text{ext})} = 1.0 \; \Omega, \\ L &= 13.6 \; \mu\text{H} \end{split}$	Fig. 14 Note 5
Diode Thermal Resistance, JCT. to Case	R _{th JC}		0.086		°C/W		Fig. 18

Note (5): SiC Schottky diodes do not have reverse recovery energy but still contribute capacitive energy

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Module Physical Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
			1.31		mΩ	T _c = 25 °C, I _{sD} = 310 A, Note 6
Package Resistance, M1 (High-Side)	R ₃₋₁		1.84			T _c = 125 °C, I _{SD} = 310 A, Note 6
	P		1.26			T _c = 25 °C, I _{sD} = 310 A, Note 6
Package Resistance, M2 (Low-Side)	R ₁₋₂		1.77			T _c = 125 °C, I _{sp} = 310 A, Note 6
Stray Inductance	L _{Stray}		11.1		nH	Between DC- and DC+, f = 10 MHz
Case Temperature	Tc	-40		125	°C	
Mounting Torque		4	5	5.5	N-m	Baseplate, M6-1.0 Bolts
	Ms	4	5	5.5		Power Terminals, M6-1.0 Bolts
Weight	W		300		g	
Case Isolation Voltage	V _{isol}	5			kV	AC, 50 Hz, 1 minute
Clearance Distance	9				Terminal to Terminal	
		30			1	Terminal to Baseplate
Creepage Distance		30			mm	Terminal to Terminal
		40				Terminal to Baseplate

Note (6): Total Effective Resistance (Per Switch Position) = MOSFET R_{DS(on)} + Switch Position Package Resistance

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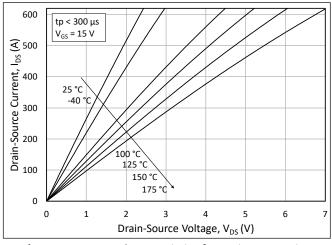


Figure 1. Output Characteristics for Various Junction Temperatures

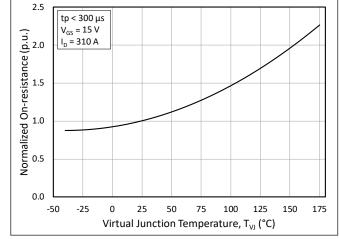
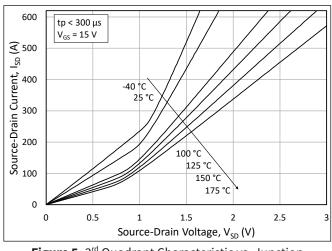
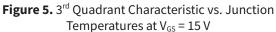


Figure 3. Normalized On-State Resistance vs. Junction Temperature





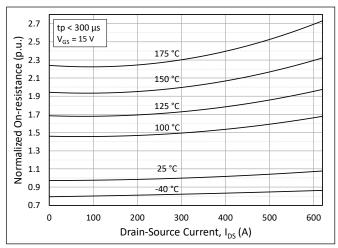


Figure 2. Normalized On-State Resistance vs. Drain Current for Various Junction Temperatures

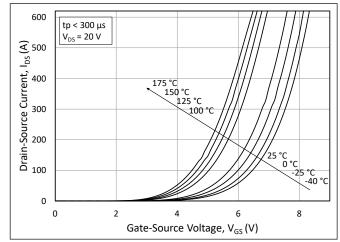
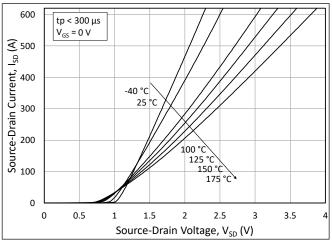


Figure 4. Transfer Characteristic for Various Junction Temperatures





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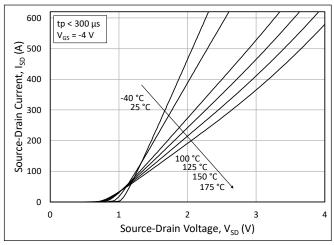


Figure 7. 3^{rd} Quadrant Characteristic vs. Junction Temperatures at V_{GS} = -4 V (Diode)

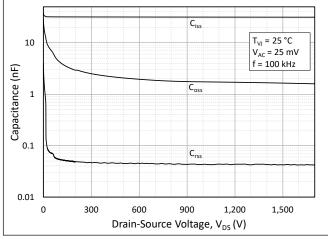


Figure 9. Typical Capacitances vs. Drain to Source Voltage (0 - 1700 V)

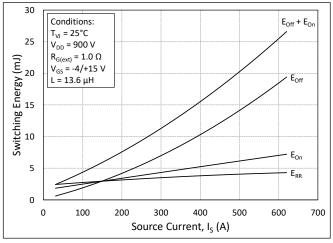


Figure 11. Switching Energy vs. Drain Current (V_{DD} = 900 V)

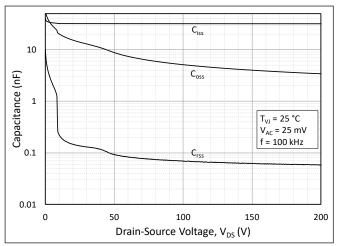


Figure 8. Typical Capacitances vs. Drain to Source Voltage (0 - 200 V)

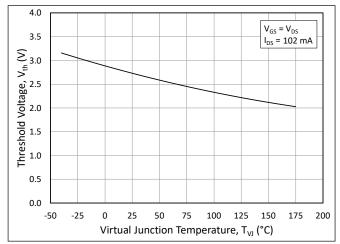


Figure 10. Threshold Voltage vs. Junction Temperature

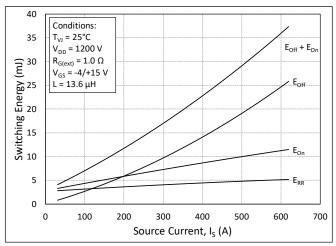
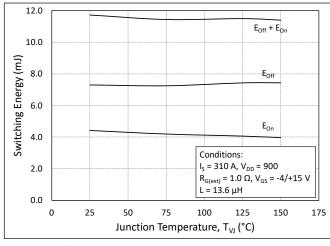
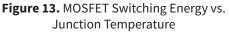


Figure 12. Switching Energy vs. Drain Current (V_{DD} = 1200 V)

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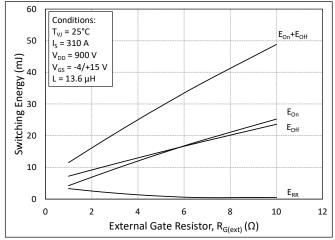
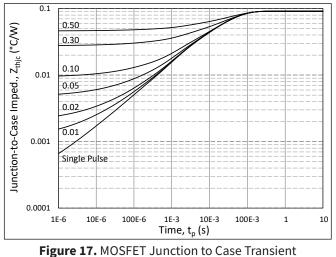


Figure 15. MOSFET Switching Energy vs. External Gate Resistance



Thermal Impedance, Z_{th,jc} (°C/W)

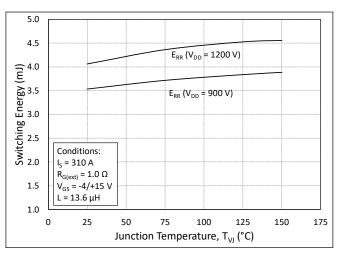


Figure 14. Reverse Recovery Energy vs. Junction Temperature

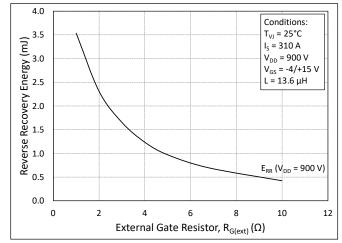


Figure 16. Reverse Recovery Energy vs. External Gate Resistance

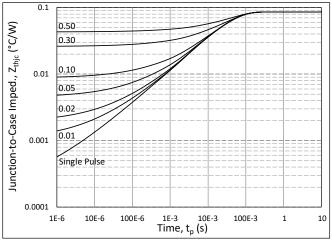


Figure 18. Diode Junction to Case Transient Thermal Impedance, Z_{th,jc} (°C/W)

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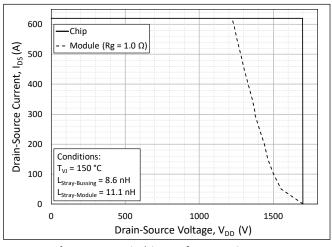


Figure 19. Switching Safe Operating Area

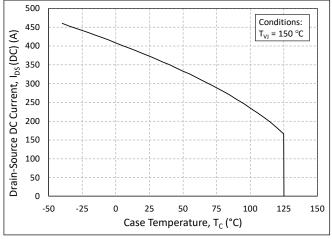
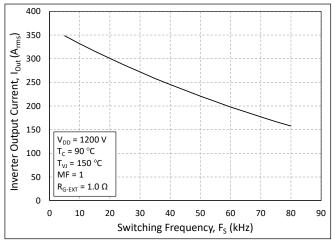
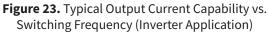


Figure 21. Continuous Drain Current Derating vs. Case Temperature





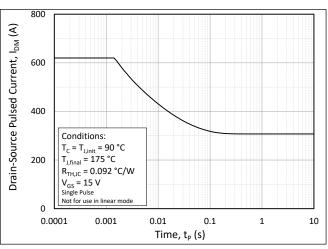


Figure 20. Pulsed Current Safe Operating Area

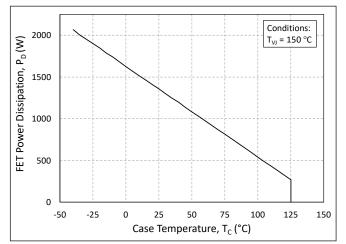


Figure 22. Maximum Power Dissipation Derating vs. Case Temperature

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Timing Characteristics

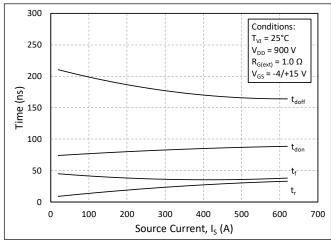


Figure 24. Timing vs. Source Current

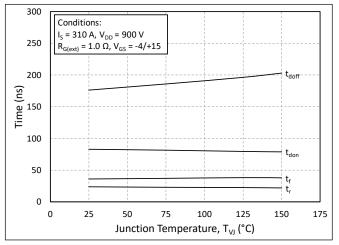
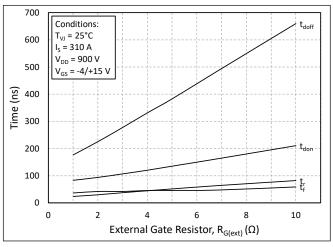


Figure 26. Timing vs. Junction Temperature





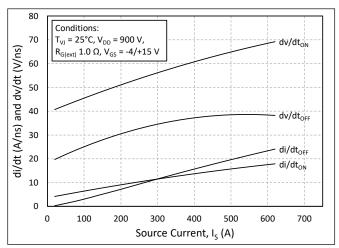


Figure 25. dv/dt and di/dt vs. Source Current

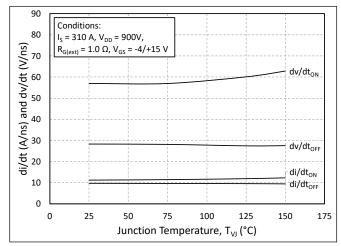


Figure 27. dv/dt and di/dt vs. Junction Temperature

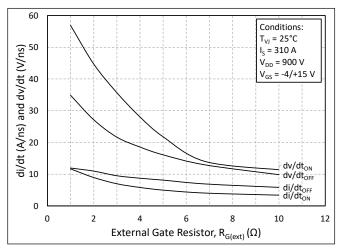


Figure 29. dv/dt and di/dt vs. External Gate Resistance

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Definitions

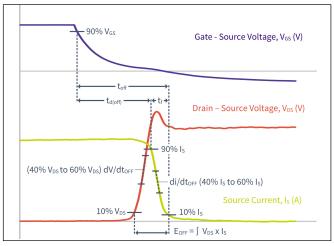


Figure 30. Turn-Off Transient Definitions

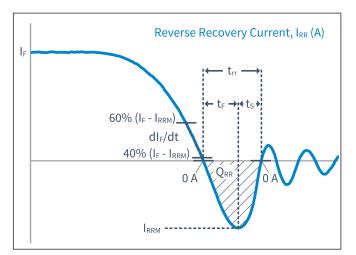


Figure 32. Reverse Recovery Definitions

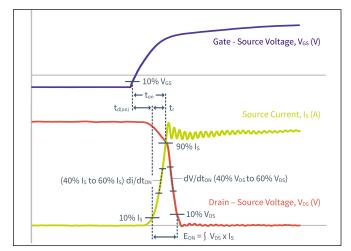


Figure 31. Turn-On Transient Definitions

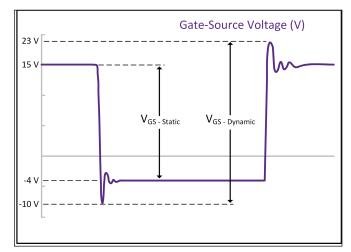


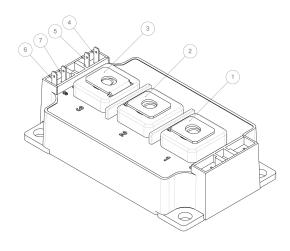
Figure 33. V_{GS} Transient Definitions

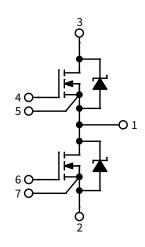
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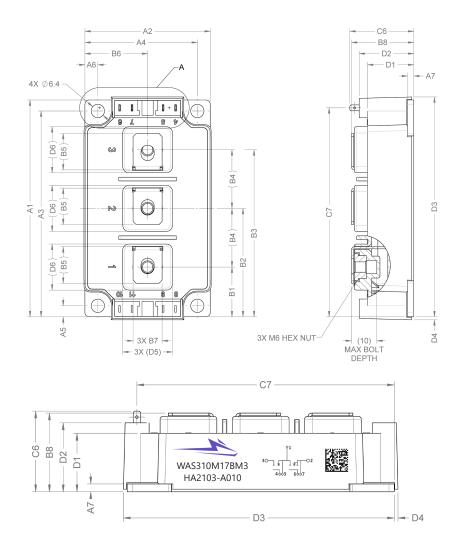


Schematic and Pin Out

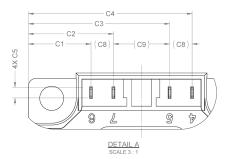




Package Dimension (mm)



DIMENSION TABLE					
SYMBOL	DIMENSION	TOLERANCE			
A1	103.5	±0.30			
A2	60.44	±0.30			
A3	98.25	±0.30			
A4	54.22	±0.30			
A5	5.25	±0.30			
A6	6.22	±0.30			
A7	3	±0.30			
B1	23.75	±0.40			
B2	51.75	±0.40			
B3	79.75	±0.40			
B4	(28)	REF.			
B5	(17.43)	REF.			
B6	30.23	±0.40			
B7	(14)	REF.			
B8	30.03	±0.40			
C1	16.73	±0.40			
C2	22.73	±0.40			
C3	37.73	±0.40			
C4	43.73	±0.40			
C5	2.8	±0.40			
C6	30.8	±0.50			
C7	99.75	±0.40			
C8	(6)	REF.			
C9	(15)	REF.			
D1	22.3	±0.30			
D2	26.3	±0.30			
D3	104.95	±0.30			
D4	1.45	±0.40			
D5	(24)	REF.			
D6	(22)	REF.			



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Product Ordering Code

Part Number	Description		
WAS310M17BM3	Without Pre-Applied Phase Change Thermal Interface Material		
WAS310M17BM3T	With Pre-Applied Phase Change Thermal Interface Material		

Supporting Links & Tools

Simulation Tools & Support

- All LTSpice Models
- All PLECS Models
- <u>SpeedFit 2.0 Design Simulator™</u>
- <u>Technical Support Forum</u>

Compatible Evaluation Hardware

- CGD1200HB2P-BM3: Dual Channel Differential Isolated Half Bridge Gate Driver Board
- KIT-CRD-CIL12N-BM: Dynamic Performance Evaluation Board for the BM2 and BM3 Module
- <u>CGD1700HB2P-BM3: Evaluation Gate Driver Tool Optimized for the 1700 V BM3 Power Modules</u>
- KIT-CRD-CIL17N-BM: Dynamic Characterization Evaluation Tool Optimized for 1700 V BM Power Modules
- <u>CGD12HB00D: Differential Transceiver Daughter Board Companion Tool for Differential Gate Drivers</u>

Application Notes

- PRD-07933: Wolfspeed Power Module Thermal Interface Material Application User Guide
- PRD-06379: Environmental Considerations for Power Electronics
- PRD-08710: Measuring Stray Inductance in Power Electronic Systems
- PRD-07845: Power Module Baseplate Capacitance and Electromagnetic Compatibility
- PRD-08376: Thermal Characterization Methods and Applications
- PRD-06933: Capacitance Ratio and Parasitic Turn-On



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